

NS6130-10-1055

COPPER

Sputtering Target

Quick Facts

Product	:	Copper Sputtering Target
Stock No	:	NS6130-10-1055
CAS	:	7440-50-8
Purity	:	99.99%
Molecular Formula	:	Cu

Technical Specification

Diameter	Thickness	Molecular Weight
50.8 mm ± 1mm	3 mm ± 0.5mm	63.547 g/mol

Copper sputtering targets have a range of properties, including high electrical conductivity, excellent thermal conductivity, and good adhesion to various substrate materials. They are commonly used in the production of interconnects and electrodes in microelectronics and semiconductor devices, as well as in the production of other electronic components, such as solar cells and touch screens.

